Cooling paste | 1 pcs | ≥1.63W/m-k | White

General information

This Nedis® cooling paste is very heat conductive. It fills in all those microscopic imperfections on the heatsink and CPU/GPU that can trap air in them and cause a loss in the heatsink’s performance. The cooling paste ensures an outstanding heat conduction and dissipation. This allows you to run heavy programs without the motherboard getting overheated.

Features

• High stability and reliability
• Suitable to be applied to CPU, UPS, inverter, chipset and other PC components
• Low thermal resistance, high conductivity for heat transfer

Specifications

Colour:	White
Content:	1 pcs
Moment beared temperature:	-50-340 °C
Operating temperature:	-30-300 °C
Type:	Paste
Specific gravity:	≥2
Thermal conductivity:	≥1.63W/m-k
Thermal impedance:	≤0.249 °C-in²/W
Thixotropic index:	350 ± 10
Viscosity:	1000
Height:	9 mm
Weight:	4 g
Depth:	134 mm
Width:	19 mm

Package contents



Sales information

Order code:	**COOLP101WT**
Product description:	Cooling paste | 1 pcs | ≥1.63W/m-k | White
Packaging:	Blister
Brand name:	Nedis

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Quantity	LxWxH (mm)			Weight
1	95 mm	20 mm	185 mm	24 g
20	210 mm	125 mm	215 mm	500 g
40	245 mm	240 mm	265 mm	1320 g


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